G3VM-41LR10

MOS FET Relays

World's Smallest* SSOP Package MOS FET Relays (Coff (typical): 0.45 pF, Ron (typical): 12 Ω) with Low Output Capacitance and ON Resistance (C \times R = 5 pF • Ω) in a 40-V Load Voltage Model.

• Output capacitance of 0.45 pF (typical) allows high-frequency applications.

* As of March 2011 Survey by OMRON

Note: The actual product is marked differently from the image shown here.



■ Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity Number per tape and reel
SSOP4	1a (SPST-NO)	Surface-mounting Terminals	40 V	G3VM-41LR10	-
				G3VM-41LR10 (TR05)	500
				G3VM-41LR10 (TR)	1,500

Note: Ask your OMRON representative for orders under 1,500 pcs or 500 pcs. We can supply products with the tape already cut. Tape-cut SSOPs are packaged without humidity resistance. Use manual soldering to mount them. Refer to common precautions.

■ Absolute Maximum Ratings (Ta = 25 °C)

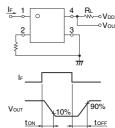
Item		Symbol	Rating Unit		Measurement conditions		
	LED forward current	lF	30	mA			
Input	LED forward current reduction rate	∆lf/°C	-0.3	mA/°C	Ta ≥ 25 °C		
	LED reverse voltage	VR	5	V			
	Connection temperature	TJ	125	°C			
Output	Load voltage (AC peak/DC)	Voff	40	V			
	Continuous load current (AC peak/DC)	lo	120	mA			
	ON current reduction rate	∆lo/°C	-1.2	mA/°C	Ta ≥ 25 °C		
	Connection temperature	TJ	125	ô			
Dielectric strength between I/O (See note 1.)		V _I -O	1500	Vrms	AC for 1 min		
Ambient operating temperature		Ta	-20 to +85	ô	With no icing or condensation		
Ambient storage temperature		Tstg	-40 to +125	°C	With no icing or condensation		
Soldering temperature		-	260	ô	10 s		

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25 °C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
		•					
	LED forward voltage	VF	1.15	1.35	1.45	V	IF = 5 mA
Input	Reverse current	IR	-	-	10	μΑ	VR = 5 V
	Capacity between terminals	Ст	-	70	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	-	3	mΑ	lo = 100 mA
Output	Maximum resistance with output ON	Ron	-	12	14	Ω	IF = 5 mA, Io = 120 mA, t < 1 s
	Current leakage when the relay is open	ILEAK	-	10	200	pΑ	Voff = 35 V, Ta = 25 °C
ō	Capacity between terminals	Coff	-	0.45	0.8	pF	V = 0, $f = 100 MHz$, $t < 1 s$
Capacity between I/O terminals		Cı-o	-	0.3	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Rı-o	1000	-	-	МΩ	V _I -o = 500 VDC, RoH ≤ 60 %
Turn-ON time		ton	-	-	0.2	ms	IF = 5 mA, RL = 200 Ω ,
Turn-OFF time		toff	-	-	0.3	ms	V _{DD} = 10 V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



^{*} The AC peak and DC value are given for the load voltage.

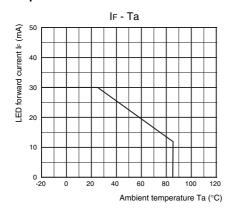
■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

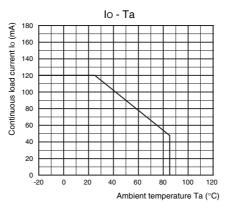
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	-	-	32	V
Operating LED forward current	lF	-	-	20	mA
Continuous load current (AC peak/DC)	lo	-	-	120	mA
Ambient operating temperature	Ta	25	-	60	°C

■ Engineering Data

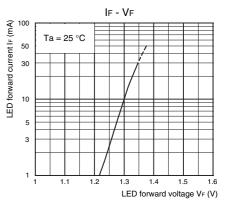
LED forward current vs. Ambient temperature



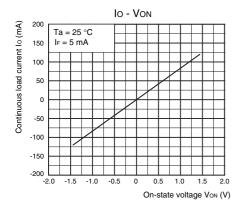
Continuous load current vs. Ambient temperature



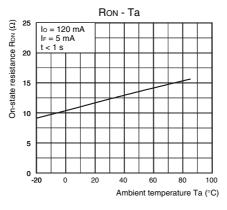
LED forward current vs. LED forward voltage



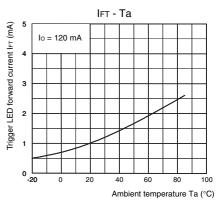
Continuous load current vs. On-state voltage



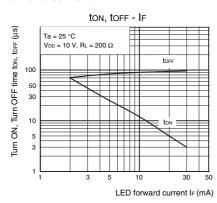
On-state resistance vs. Ambient temperature



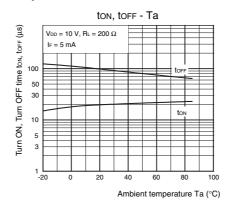
Trigger LED forward current vs. Ambient temperature



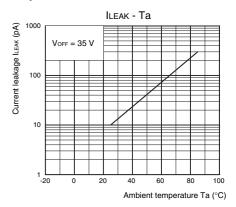
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



■ Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

This announcement is based on product catalogue information previously shown before its discontinuation

Product information of the existing product may be different from the previous version

■ Appearance

SSOP (Shrink Small Outline Package)

SSOP4



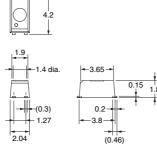
Note: The actual product is marked differently from the image shown here.

■ Dimensions (Unit: mm)



Surface-mounting Terminals

Weight: 0.03 g



Unless otherwise specified, the dimensional tolerance is \pm 0.1 mm.

Note: The actual product is marked differently from the image shown here.

Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



Note: Do not use this document to operate the Unit.

Contact: www.omron.com/ecb

OMRON Corporation

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.

[•] Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.